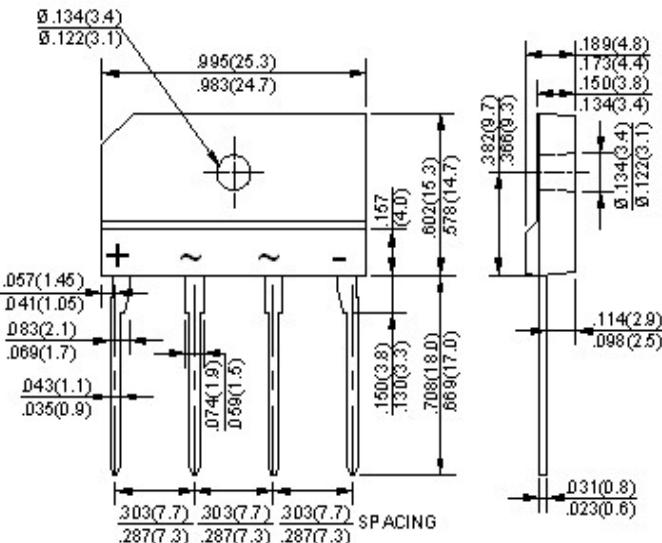


Package: 4GBJ


Dimensions in inches and (millimeters)

FEATURES

- Ideal for printed circuit board
- Low forward voltage drop, high current capability
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product
- The plastic material has UL flammability classification 94V-0

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%

CHARACTERISTICS	SYMBOL	GBJ2006	UNIT
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	600	V
Maximum RMS Voltage	V _{RMS}	420	V
Maximum DC Blocking Voltage	V _{DC}	600	V
Maximum Average Forward (with heatsink Note 2) Rectified Current @ T _J =100°C (without heatsink)	I _(AV)	20.0 4.1	A
Peak Forward Surge Current 8.3ms Single Half Sine-Wave Super Imposed on Rated Load (JEDEC Method)	I _{FSM}	240	A
Maximum Forward Voltage at 10A DC	V _F	1.1	V
Maximum DC Reverse Current @ T _J =25°C at Rated DC Blocking Voltage @ T _J =125°C	I _R	5.0 500	uA
I ² t Rating for Fusing (t<8.3ms)	I ² t	239	A ² s
Typical Junction Capacitance Per Element (Note1)	C _J	60	pF
Typical Thermal Resistance (Note2)	R _{θJC}	0.93	°C/W
Operating Temperature Range	T _J	-55 to +150	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

NOTES: 1. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

2. Device mounted on 300mm*300mm*1.6mm cu plate heatsink.

RATING AND CHARACTERISTIC CURVES

